

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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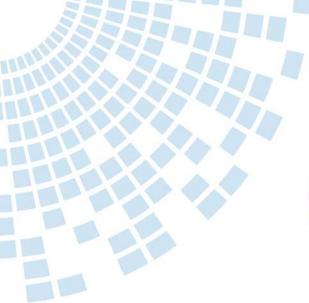
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









### Surface Mount Fast Acting Chip Fuse

HF @ C2F Series - 0603 Size

**RoHS 6 Compliant** 

#### **Features**

- Fast Acting, with improved surge withstand performance
- Small size, 0603 SMD
- Current rating from 500mA to 8A, fuse marked with ampere code
- Wide operating temperature range from -55 °C to 125 °C
- Tape and Reel for automatic SMD placement
- Compatible with 260 °C IR Pb-free and wave soldering process
- RoHS 6 compliant (MSL = 1)
- Halogen Free
- Leadfree

#### **Applications**

- Notebook
- LCD monitor
- PC computer
- Office electronic equipment
- Industrial equipment
- Medical equipment
- POE, POE+
- LCD / LED monitor
- Power supply
- LCD / LED TV
- DC-DC Converter

LEAD FREE =

(Pb)

HALOGEN FREE = HF

### Typical Part Marking

Fuse body (ceramic white side) marked with marking code.

#### Example:

c**™**us C €



Current Rating	Marking Code	Current Rating	Marking Code
500mA	J	3A	3
750mA	М	3.5A	Z
1A	1	4A	4
1.25A	Р	5A	5
1.5A	R	6A	6
2A	2	7A	7
254	т	ΩΔ	Ω

#### Electrical Characteristics (UL STD. 248-14)

	Blow	Time	
Testing Current	Minimum	Maximum	
100%	4 Hrs.	N/A	
200%	N/A	5 Sec	
300%	N/A	0.2 Sec	

#### Safety Agency Approvals

SAFETY	SAFETY AGENCY	VOLTAGE RATING	AMPERE RANGE / VOLT
AGENCY	CERTIFICATE	(V)	@ I.R. ABILITY*
c <b>91</b> .us	E20624	500mA - 8A / 32V AC 63V DC	500mA - 8A / 35A@ 32V AC 50A@ 63V DC

#### **Physical Specifications**

	Body : Ceramic Substrate
Materials	Terminations : Ag / Ni / Sn (100% Lead-free)
	Element Cover Coating : Lead-free Glass
Marking	On Fuse :
	Marking Code
	On Label :
	"bel", "C2F", "Current Rating", "Voltage Rating", "Interrupting Rating", "Appropriate Safety Logos" and "

Specifications subject to change without notice



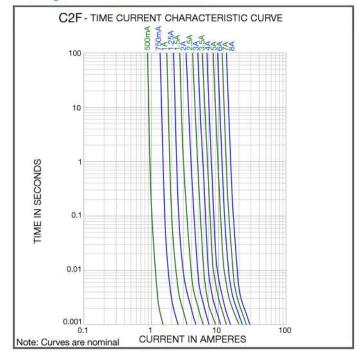
Bel Fuse Inc. 206 Van Vorst Street Jersey City, NJ 07302 USA

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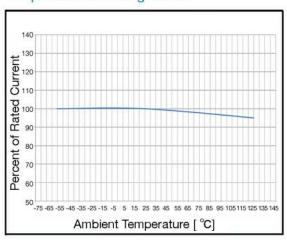


**RoHS 6 Compliant** 

#### Average Time Current Curve



#### Temperature Derating Curve



### **Electrical Specifications**

Part Number	Ampere Rating (A)	Marking Code	Nominal Cold Resistance (ohms)	Maximum Volt-drop @100% In (Volt) max.	Voltage and Interrupting Ratings	Nominal Melting I <sup>2</sup> T @10 In (A <sup>2</sup> Sec)	Maximum Power Dissipation @100% In (W)	Agency Approvals
0686F0500-XX	500mA	J	0.430	0.310		0.0003	0.16	Y
0686F0750-XX	750mA	М	0.225	0.230		0.0013	0.17	Υ
0686F1000-XX	1A	1	0.150	0.215	See Table of Safety Approvals on Page 1 for Voltage and associated Interrupting Ratings	0.0028	0.22	Υ
0686F1250-XX	1.25A	Р	0.110	0.195		0.0045	0.24	Υ
0686F1500-XX	1.5A	R	0.088	0.185		0.008	0.28	Υ
0686F2000-XX	2A	2	0.060	0.180		0.014	0.36	Y
0686F2500-XX	2.5A	T	0.035	0.115		0.027	0.29	Υ
0686F3000-XX	3A	3	0.026	0.110		0.040	0.33	Υ
0686F3500-XX	3.5A	Z	0.021	0.103		0.058	0.36	Υ
0686F4000-XX	4A	4	0.017	0.100		0.110	0.40	Υ
0686F5000-XX	5A	5	0.0135	0.098		0.140	0.49	Υ
0686F6000-XX	6A	6	0.0113	0.106		0.210	0.64	Υ
0686F7000-XX	7A	7	0.0092	0.107		0.350	0.75	Y
0686F8000-XX	8A	8	0.0075	0.097		0.500	0.78	Υ

Consult manufacturer for other ratings

Specifications subject to change without notice

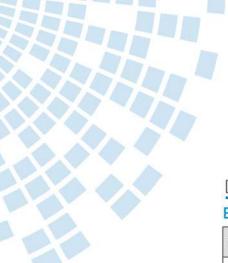
NOTES: Test Conditions
All test for ratings 500mA - 5A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.035 mm (35µm) nominal thickness (1 oz.clad), 5mm wide and 100 mm overall length.
All test for ratings 6A-8A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.070 mm (70µm) nominal thickness (2 oz. clad), 7.5mm wide and 100 mm overall length.

Device designed to be mounted with marking facing up.

Device designed to carry rated current for 4 hours minimum. It is recommended that device be operated continuously at no more than 80% of rated current when in a +25°C ambient, with further derating at elevated ambient temperatures.



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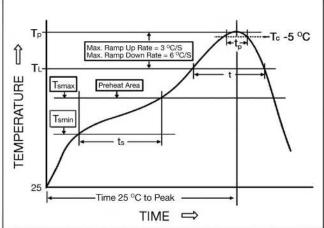
### **Environmental Specifications**

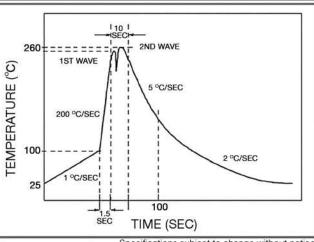
Shock Resistance	MIL-STD-202G, Method 213B, Test Condition 1 (100 G's peak for 6 milliseconds; Sawtooth waveform)
Vibration Resistance	MIL-STD-202G, Method 201A(10-55 Hz,0.06 inch, total excursion).
Salt Spray Resistance	MIL-STD-202G, Method 101E, Test Condition B(48 hrs).
Insulation Resistance	MIL-STD-202G, Method 302, Test Condition A (After Opening) 10,000 ohms minimum.
Solderability	MIL-STD-202G, Method 208H
Resistance to solder Heat	MIL-STD-202G, Method 210F, Test Condition C. Top Side(260 °C,20 sec) MIL-STD-202G, Method 210F, Test Condition D.Bottom Side(260 °C,10 sec)
Thermal Shock	MIL-STD-202G, Method 107G, Test Condition B (-65 °C to +125 °C).
Operating Temperature	-55 °C to +125 °C
Moisture Sensitivity Level	1 (According to IPC J-Std-020)

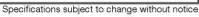
### Soldering Parameters

	- 0
Preheat & Soak Temperature min (Tsmin) Temperature max (Tsmax) Time (Tsmin to Tsmax) (ts)	150 °C 200 °C 60 -120 seconds
Average ramp-up rate (Tsmax to Tp)	3 °C/second max.
Liquidous temperature (TL) Time at liquidous (tL)	217 °C 60 - 150 seconds
Peak temperature (Tp)	260 °C max
Time (tp) within 5 °C of the specified classification temperture (Tc)	30 seconds
Average ramp-down rate (Tp to Tsmax)	6 °C/second max.
Time 25 °C to peak temperature	8 minutes max.

Lead-free Wave Soldering Profile	
Wave Soldering Parameter	
Average ramp-up rate	200 °C / second
Heating rate during preheat	typical 1 - 2 °C / second Max 4 °C / second
Final preheat temperature	within 125 °C of soldering temperature
Peak temperature Tp	260 °C
Time within +0 °C / -5 °C of actual peak temperature	10 seconds
Ramp-down rate	5 °C / second max.

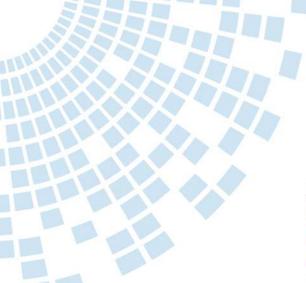








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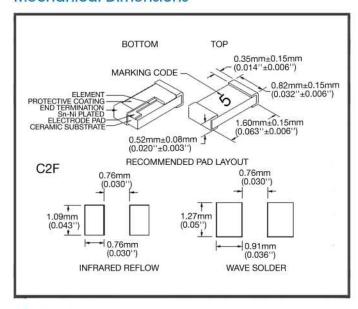
**RoHS 6 Compliant** 

# Fuse FGNO Explanation 0686 F [XXXX] X XX

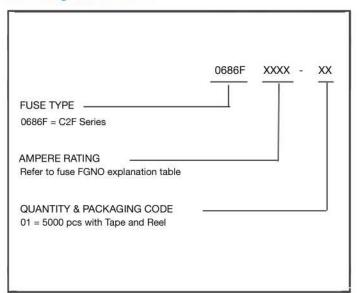
0686F=C2F; [XXXX]=Ampere Rating; XX=See Ordering Information as below

Fraction	Decimal	Milliamps	Bel FGNO[XXXX]	Fraction	Decimal	Amps	Bel FGNO[XXX
1/2	0.500	500	0500		1.0	1	1000
3/4	.750	750	0750	1-1/4	1.25	1.25	1250
				1-1/2	1.50	1.5	1500
					2.0	2	2000
				2-1/2	2.5	2.5	2500
		1			3.0	3	3000
				3-1/2	3.5	3.5	3500
					4.0	4	4000
					5.0	5	5000
				-	6.0	6	6000
	(				7.0	7	7000
					8.0	8	8000

#### **Mechanical Dimensions**



#### **Ordering Information**



#### Packaging

Packaging Tape & Reel	Packaging Specification	Quantity	Quantity & Packaging Code	
8 mm wide tape with 7 inches Diameter reel	EIA Standard 481-E	5000	0686FXXXX-01	

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